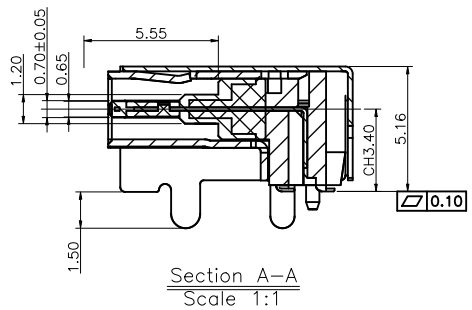
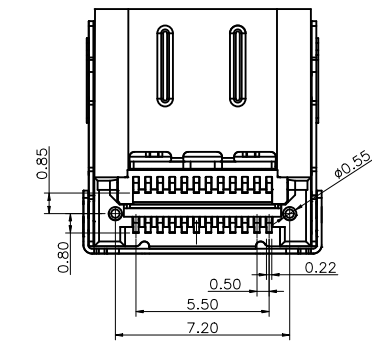
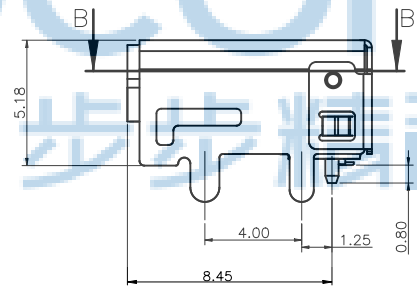
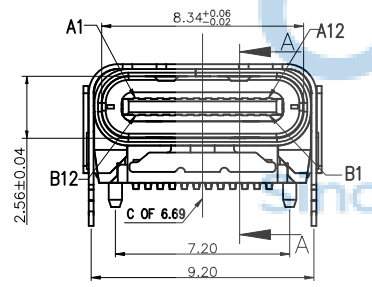
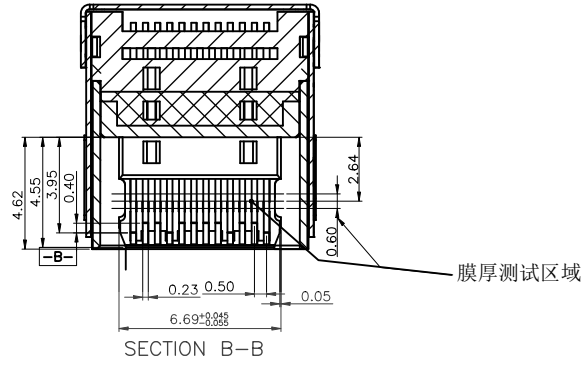
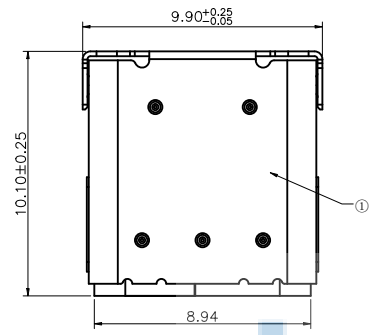
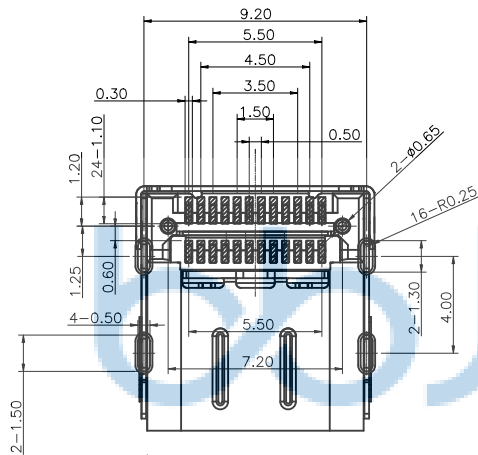


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF

NOTES:
 1.MATERIAL:
 MOLDING: LCP UL94 V-0
 CONTACT:COPPER ALLOY.
 PLATED GOLD ON CONTACT AREA,
 G/F GOLD ON SOLDER AREA,
 50u" NICKEL PLATING OVER ALL.
 SHELL: SUS304,T=0.20±0.03mm
 50u" NICKEL PLATING OVER ALL.
 SHELL2:SUS304,T=0.15±0.03mm
 LATCH:SUS301,T=0.15±0.03mm
 2.MECHANICAL:
 INSERTION: 5~20N.
 EXTRACTION: 8~20N.
 DURABILITY: 10000 CYCLES
 3.ELECTRICAL:
 CURRENT: 5A MAX FOR VBUS;
 1.25A FOR GND,0.25A FOR OTHER OTHER.
 VOLTAGE: 20VDC MAX
 WITHSTANDING VOLTAGE: 100V AC.
 CONTACT RESISTANCE: 40mΩ MAX.
 INSULATION RESISTANCE: 100MΩ MIN.
 4.ENVIRONMENTAL
 TEMPERATURE RANGE -25°C ~ +85°C



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13 X': ±3' .X': ±2' .XX': ±1'		NAME: TYPE-C 24P 母座 双壳 板上型 双排SMT 四脚插 带柱 脚长1.5 L=10.10 CH=3.4 编带	
APPD.	JM_Zheng	PJ. NO.: 126-221-240001-T7G	
CHKD.	LYX	SIZE: A4 DRW NO.:	
DR.	SGF	FINISH: SEE NOTES	MAT'L: SEE NOTES
PDWG.NO:	0228-1	SCALE: N/A	REV.: A0
		UNIT: mm	PAGE: 1/4



RECOMMENDED PCB LAYOUT(COMPONENT SIDE)

PCB THICKNESS: 1.60±0.05
DEFAULT TOLERANCE: ±0.05

USB TYPE-C FULL-FEATURED RECEPTACLE INTERFACE PIN ASSIGNMENTS

PIN	Signal Name	Description	PIN	Signal Name	Description
A1	GND	Ground return	B12	GND	Ground return
A2	SSTxp1	Positive half of first SuperSpeed TX differential pair	B11	SSRXp1	Positive half of first SuperSpeed RX differential pair
A3	SSTxn1	Negative half of first SuperSpeed TX differential pair	B10	SSRXn1	Negative half of first SuperSpeed RX differential pair
A4	VBUS	Bus Power	B9	VBUS	Bus Power
A5	CC1	Configuration Channel	B8	SBU2	Sideband Use (SBU)
A6	Dp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Dn2	Negative half of the USB 2.0 differential pair-Position 2
A7	Dn1	Negative half of the USB 2.0 differential pair-Position 1	B6	Dp2	Positive half of the USB 2.0 differential pair-Position 2
A8	SBU1	Sideband Use (SBU)	B5	CC2	Configuration Channel
A9	VBUS	Bus Power	B4	VBUS	Bus Power
A10	SSRXn2	Negative half of second SuperSpeed RX differential pair	B3	SSTx2	Negative half of second SuperSpeed TX differential pair
A11	SSRXp2	Positive half of second SuperSpeed RX differential pair	B2	SSTx2	Positive half of second SuperSpeed TX differential pair
A12	GND	Ground return	B1	GND	Ground return

8	UPPER CONTACT	12	COPPER ALLOY	PLATED GOLD ON CONTACT AREA, G/F, GOLD ON SOLDER AREA, 50u" NICKEL PLATING OVER ALL.
7	LOWER CONTACT	12		
6	LOWER IM	1	THERMOPLASTIC UL 94V-0	COLOR: BLACK
5	UPPER IM	1	THERMOPLASTIC UL 94V-0	COLOR: BLACK
4	OVERMOLD	1	THERMOPLASTIC UL 94V-0	COLOR: BLACK
3	SHIELD PLATE	1	STAINLESS STEEL	NICKEL PLATING AT OVER ALL
2	INNER SHELL	1	STAINLESS STEEL	CLEAN
1	OUTER SHELL	1	STAINLESS STEEL	NICKEL PLATING ONLY AT TAIL,AU AT SOLDER TAIL
NO.	DESCRIPTION	QTY	MATERIAL	SPECIFICATION



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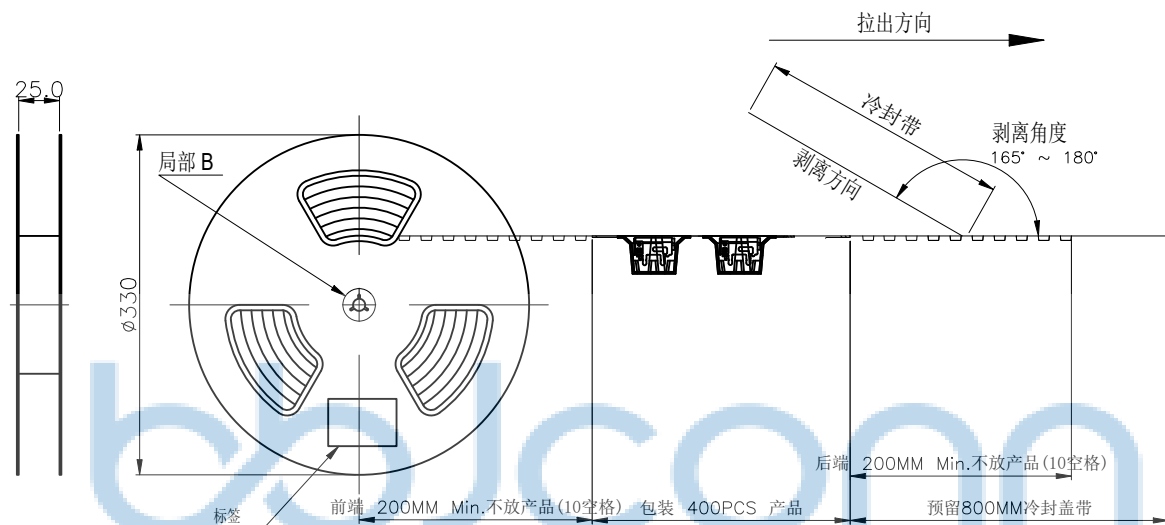
BBJconn 深圳市步步精科技有限公司

NAME: TYPE-C 24P 母座 双壳 板上型 双排SMT 四脚插
带柱 脚长1.5 L=10.10 CH=3.4 编带

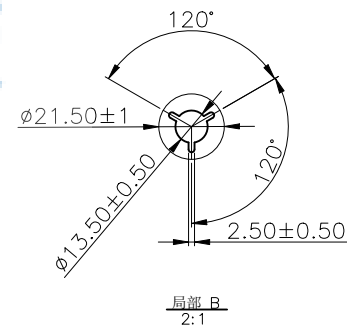
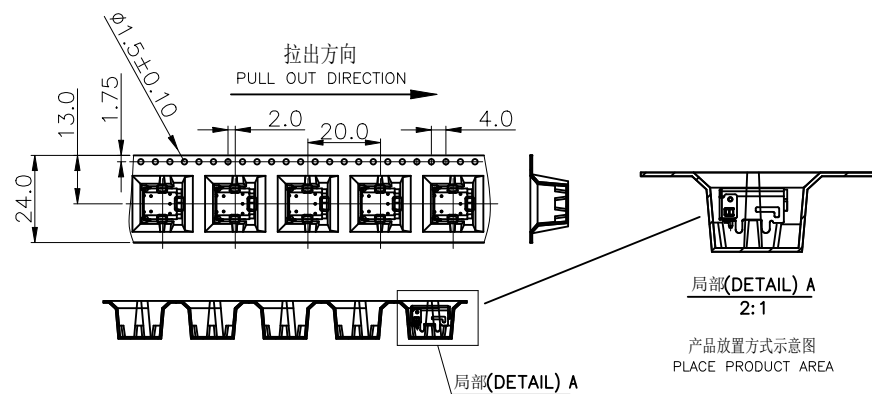
APPD: JM_Zheng
CHKD: LYX
DR: SGF

PJ. NO.: 126-221-240001-T7G
SIZE: A4 DRW NO.:
FINISH: SEE NOTES MAT'L: SEE NOTES
SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/4

REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF



Since 1987 步步精科技



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深圳市步步精科技有限公司

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NAME: TYPE-C 24P 母座 双壳 板上型 双排SMT 四脚插
带柱 脚长1.5 L=10.10 CH=3.4 编带

APPD. JM_Zheng

PJ. NO.: 126-221-240001-T7G

CHKD. LYX

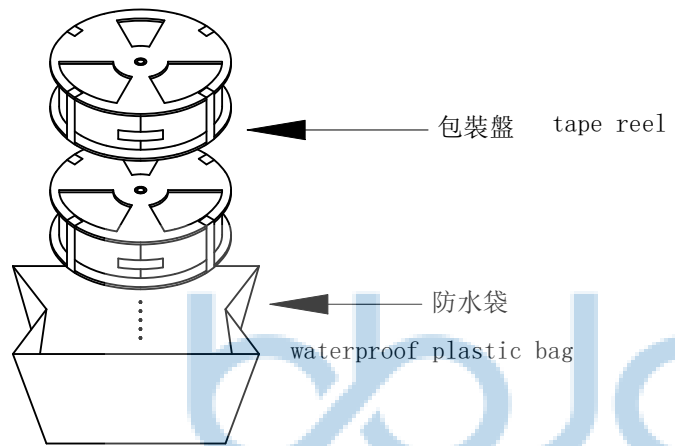
SIZE: A4 DRW NO.:

DR. SGF

FINISH: SEE NOTES MAT'L: SEE NOTES

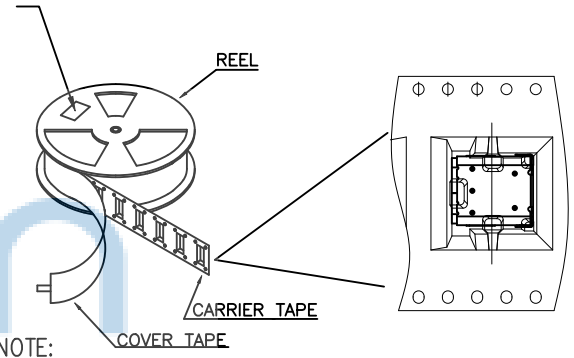
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REV.	ECN NO.	CONTENT	DATE	ENGINEER
AO		Initial release	/	SGF



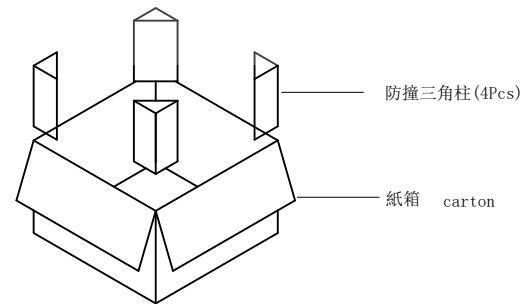
at small positioning hole of the carrier tape side.
標籤黏貼處 (朝捲裝包材的小定位孔一側)

Location of label sticking (label)



NOTE:

1. 每卷包裝數量及每箱裝箱數量如左下表格。
Packing q'ty of each reel & carton as below table shown.
2. 以上帶覆蓋下載帶經包裝機自粘包裝
The above tape covers the download tape by self-adhesive packaging machine.
3. 將裝滿產品的卷盤放入紙箱並以膠帶封口
Put reels in the carton and use adhesive tape to seal up.



NOTE:

1. 每卷包裝數量: 400 PCS/卷;
2. 每箱包裝數量: 400 X 10= 4000 PCS / 箱 .
3. 紙箱規格340*340*380



产品料号 (PRODUCT No.)	包装数量 (PACKING CAPACITY)			重量 WEIGHT (Kg)		
	PCS/REEL	REELS/CARTON	PCS/CARTON	N.W./PCS	N.W./BOX	G.W./BOX
	400	10	4000	0.782		

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